

SE10DB, SE10DD, SE10DG, SE10DJ

Vishay General Semiconductor

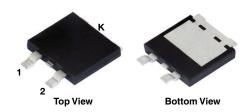
AUTOMOTIVE

COMPLIANT

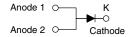
HALOGEN

Surface-Mount ESD Capability Rectifiers

eSMP® Series SMPD (TO-263AC)



SE10DX



ADDITIONAL RESOURCES



PRIMARY CHARACTERISTICS					
I _{F(AV)}	10 A				
V _{RRM}	100 V, 200 V, 400 V, 600 V				
I _{FSM}	110 A				
V_F at $I_F = 10$ A ($T_A = 125$ °C)	0.96 V				
I _R	15 μΑ				
T _J max.	175 °C				
Package	SMPD (TO-263AC)				
Circuit configuration	Single				

FEATURES

- Very low profile typical height of 1.7 mm
- · Ideal for automated placement
- Oxide planar chip junction
- · Low forward voltage drop
- ESD capability
- AEC-Q101 qualified
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

TYPICAL APPLICATIONS

General purpose, power line polarity protection, in both consumer and automotive applications.

MECHANICAL DATA

Case: SMPD (TO-263AC)

Molding compound meets UL 94 V-0 flammability rating Base P/N-M3 - halogen-free, RoHS-compliant, and

commercial grade

Base P/NHM3 - halogen-free, RoHS-compliant, and

AEC-Q101 qualified

Terminals: matte tin plated leads, solderable per

J-STD-002 and JESD 22-B102

M3 suffix meets JESD 201 class 2 whisker test, HM3 suffix meets JESD 201 class 2 whisker test

Polarity: as marked

MAXIMUM RATINGS (T _A = 25 °C unless otherwise noted)						
PARAMETER	SYMBOL	SE10DB	SE10DD	SE10DG	SE10DJ	UNIT
Maximum repetitive peak reverse voltage	V_{RRM}	100	200	400	600	V
Maximum DC forward current	I _F ⁽¹⁾	10			Α	
Maximum DC forward current	I _F ⁽²⁾	3.0				
Peak forward surge current 10 ms single half sine-wave superimposed on rated load	I _{FSM}	110		А		
Operating junction and storage temperature range	T_J , T_{STG}	-55 to +175			°C	

Notes

(1) With heatsink

⁽²⁾ Free air, mounted on recommended copper pad area



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ELECTRICAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted)							
PARAMETER	TEST CONDITIONS		SYMBOL	TYP.	MAX.	UNIT	
Instantaneous forward voltage	I _F = 5 A	T = 25 °C		0.95	-	V	
	I _F = 10 A	$T_A = 25 ^{\circ}\text{C}$	V _F ⁽¹⁾	1.04	1.15		
	I _F = 5 A	T _A = 125 °C	V _F ('')	0.85	-		
	I _F = 10 A			0.96	1.10		
Reverse current	Datad V	$T_A = 25 ^{\circ}\text{C}$ $T_A = 125 ^{\circ}\text{C}$ $I_R^{(2)}$	1 (2)	-	15		
	Rated V _R		22	150	- μΑ		
Typical reverse recovery time	I _F = 0.5 A, I _R = 1.0 A, I _{rr} = 0.25 A		t _{rr}	3000	-	ns	
Typical junction capacitance	4.0 V, 1 MHz		CJ	67	-	pF	

Notes

 $^{(1)}$ Pulse test: 300 μ s pulse width, 1 % duty cycle

 $^{(2)}$ Pulse test: Pulse width \leq 40 ms

THERMAL CHARACTERISTICS (T _A = 25 °c unless otherwise noted)						
PARAMETER	SYMBOL	BOL SE10DB SE10DD SE10DG SE10DJ UNIT				
Typical thormal registance	R _{θJA} (1)(2)	60			°C/W	
Typical thermal resistance	R ₀ JC (3)	1.6				C/VV

Notes

- $^{(1)}$ The heat generated must be less than the thermal conductivity from junction-to-ambient: $dP_D/dT_J < 1/R_{\theta JA}$
- $^{(2)}$ Free air, mounted on recommended PCB, 2 oz. pad area; thermal resistance $R_{\theta JA}$ junction to ambient
- (3) With infinite heatsink

IMMUNITY TO ELECTRICAL STATIC DISCHARGE TO THE FOLLOWING STANDARDS ($T_A = 25~^{\circ}\text{C}$ unless otherwise noted)						
STANDARD	TEST TYPE	TEST CONDITIONS	SYMBOL	CLASS	VALUE	
AEC-Q101-001	Human body model (contact mode)	C = 100 pF, R = 1.5 kΩ	V _C	НЗВ	> 8 kV	

ORDERING INFORMATION (Example)						
STANDARD	PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE	
SMPD (TO-263AC)	SE10DJ-M3/I	0.54	1	2000/reel	13" diameter plastic tape and reel	
SMPD (TO-263AC)	SE10DJHM3/I (1)	0.54	I	2000/reel	13" diameter plastic tape and reel	

Note

(1) AEC-Q101 qualified



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RATINGS AND CHARACTERISTICS CURVES (T_A = 25 °C unless otherwise noted)

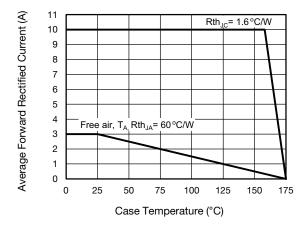


Fig. 1 - Forward Current Derating Curve

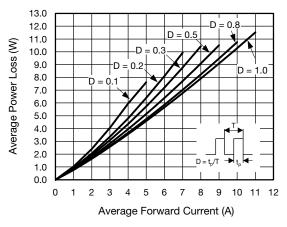


Fig. 2 - Forward Power Loss Characteristics

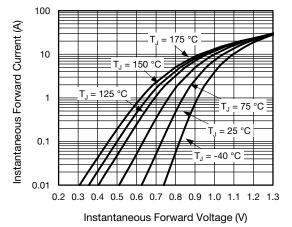


Fig. 3 - Typical Instantaneous Forward Characteristics

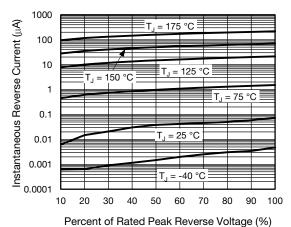


Fig. 4 - Typical Reverse Leakage Characteristics

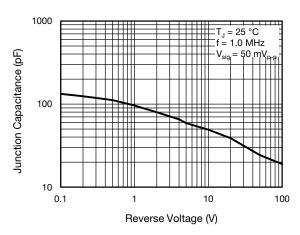


Fig. 5 - Typical Junction Capacitance

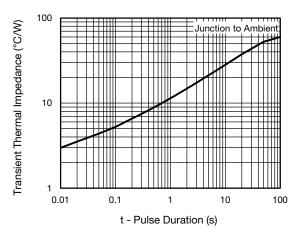


Fig. 6 - Typical Transient Thermal Impedance

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PACKAGE OUTLINE DIMENSIONS in inches (millimeters)

SMPD (TO-263AC) 0.402 (10.20) 0.071 (1.80) 0.386 (9.80) 0.020 (0.52) 0.063 (1.60) 0.059 (1.50) REF. 0.011 (0.27) 0.048 (1.21) 0.032 (0.81) 0.354 (8.99) 0.338 (8.59) 0.509 (12.93) 0.485 (12.33) 0 to 0.01 (0 to 0.254) 0.069 (1.74) 0.053 (1.34) 0.063 (1.60) 0.020 (0.52) 0.047 (1.20) 0.011 (0.27) 0.200 0.052 (1.23) NOM. (5.08) 0.028 (0.72) **Mounting Pad Layout** 0.420 (10.66) MIN. -0.339 (8.60) 0.323 (8.20) 0.276 (7.00) 0.260 (6.60) $\frac{0.330}{(8.38)}$ REF. 0.194 NOM. (4.93)0.604 (15.33) 0.525 (13.33) 0.120 (3.05) REF. 0.105 (2.67) 0.080 (2.03) MIN. 0.095 (2.41)



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